General Description

FSMOS® MOSFET is based on Oriental Semiconductor's unique device design to achieve low $R_{DS(ON)}$, low gate charge, fast switching and excellent avalanche characteristics. The high V_{th} series is specially designed to use in motor control systems with driving voltage of more than 10V.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent reliability and uniformity
- Fast switching and soft recovery

RoHS compliant

Applications

- PD charger
- Motor driver
- Switching voltage regulator
- DC-DC convertor
- Switching mode power supply

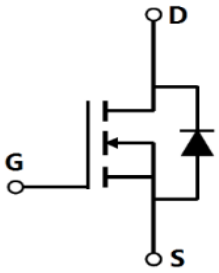
Key Performance Parameters

Parameter	Value	Unit
V_{DS}	100	V
$I_{D,\ pulse}$	1120	A
$R_{DS(ON),\ max}$ @ V_{GS}=10V	2.5	mΩ
Q_g	76	nC
PD	395	W

Marking Information

Product Name	Package	Marking
SFS10R025UT1NF	sTOLL	SFS10R025UT1N

Package & Pin information



Absolute Maximum Ratings at T_j=25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	100	V
Gate-source voltage	V_{GS}	±20	V
Continuous drain current[1], T_C=25 °C	I_D	280	A
Pulsed drain current[2], T_C=25 °C	$I_{D,\ pulse}$	1120	A
Continuous diode forward current[1], T_C=25 °C	I_S	280	A
Diode pulsed current[2], T_C=25 °C	$I_{S,\ pulse}$	1120	A
Power dissipation[3], T_C=25 °C	P_D	395	W
Single pulsed avalanche energy[5]	E_{AS}	303	mJ
Operation and storage temperature	T_{stg}, T_j	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	$R_{\theta JC}$	0.38	°C/W
Thermal resistance, junction-ambient[4]	$R_{\theta JA}$	62	°C/W

Electrical Characteristics at T_j=25°C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	100			V	V_{GS}=0 V, I_D=250 μA
Gate threshold voltage	$V_{GS(th)}$	2		4	V	V_{DS}=V_{GS}, I_D=250 μA
Drain-source on-state resistance	$R_{DS(ON)}$		2.1	2.5	mΩ	V_{GS}=10 V, I_D=50 A
Gate-source leakage current	I_{GSS}			100	nA	V_{GS}=20 V
				-100		V_{GS}=-20 V
Drain-source leakage current	I_{DSS}			1	μA	V_{DS}=100 V, V_{GS}=0 V
Gate resistance	R_G		2.7		Ω	f=1 MHz, Open drain

Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}		6215		pF	V_{GS}=0 V, V_{DS}=50 V, f=100 kHz
Output capacitance	C_{oss}		2438		pF	
Reverse transfer capacitance	C_{rss}		26		pF	
Turn-on delay time	$t_{d(on)}$		26		ns	V_{GS}=10 V, V_{DS}=50 V, R_G=3.5 Ω, I_D=50 A
Rise time	t_r		27		ns	
Turn-off delay time	$t_{d(off)}$		62		ns	
Fall time	t_f		31		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q_g		76		nC	V_{GS}=10 V, V_{DS}=50 V, I_D=50 A
Gate-source charge	Q_{gs}		27		nC	
Gate-drain charge	Q_{gd}		9		nC	
Gate plateau voltage	$V_{plateau}$		4.5		V	

Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	V_{SD}			1.3	V	I_S=50 A, V_{GS}=0 V
Reverse recovery time	t_{rr}		47		ns	V_R=50 V, I_S=100 A, di/dt=100 A/μs
Reverse recovery charge	Q_{rr}		51		nC	
Peak reverse recovery current	I_{rrm}		2.1		A	

Note

1) Calculated continuous current based on maximum allowable junction temperature.
2) Repetitive rating; pulse width limited by max. junction temperature.
3) Pd is based on max. junction temperature, using junction-case thermal resistance.
4) The value of $R_{\theta JA}$ is measured with the device mounted on 1 in^2 FR-4 board with 2oz. Copper, in a still air environment with T_a=25 °C.
5) V_{DD}=50 V,V_{GS}=10 V, L=0.3 mH, starting T_j=25 °C.

Electrical Characteristics Diagrams

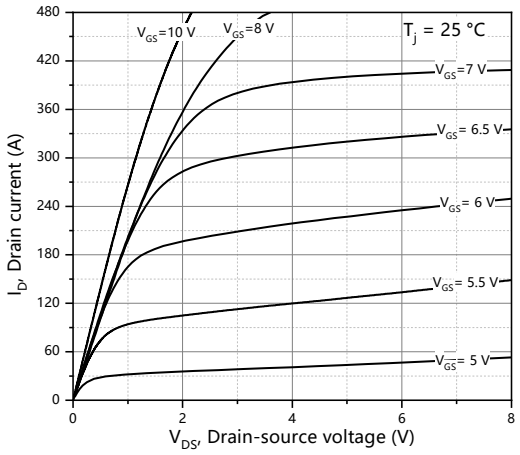


Figure 1. Typ. output characteristics

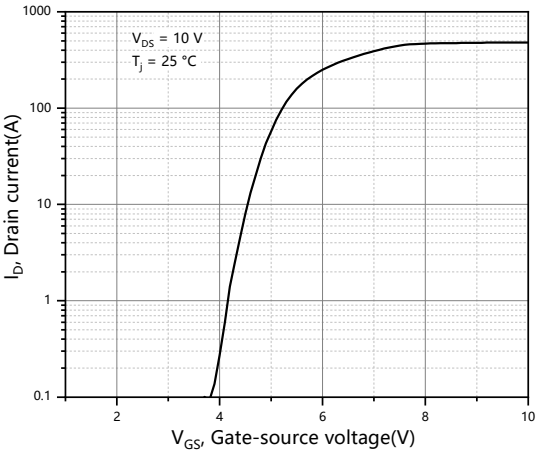


Figure 2. Typ. transfer characteristics

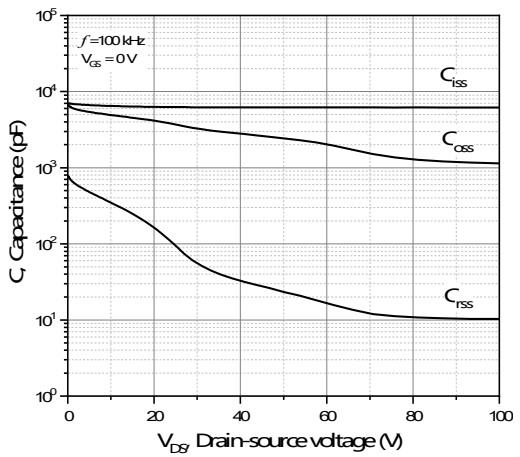


Figure 3. Typ. capacitances

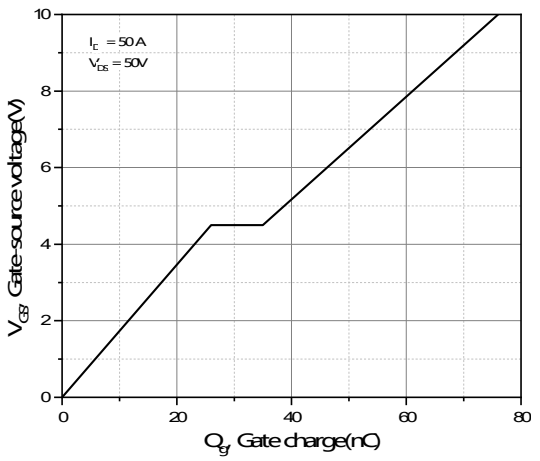


Figure 4. Typ. gate charge

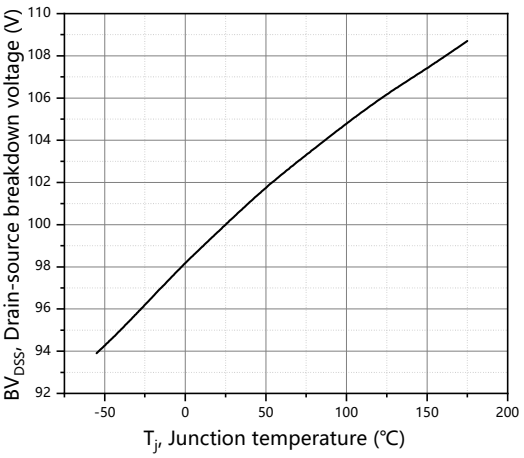


Figure 5. Drain-source breakdown voltage

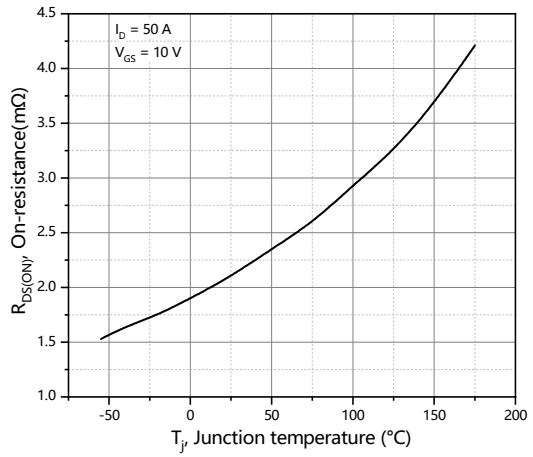


Figure 6. Drain-source on-state resistance

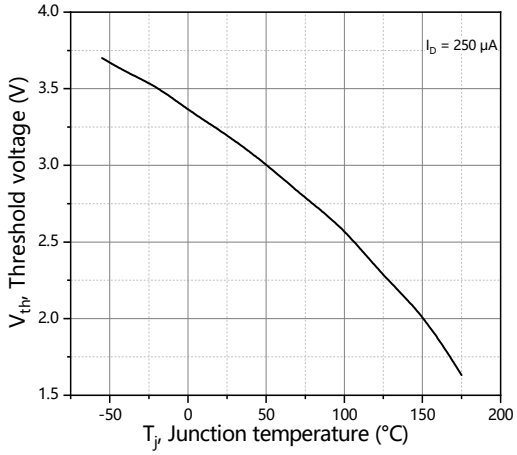


Figure 7. Threshold voltage

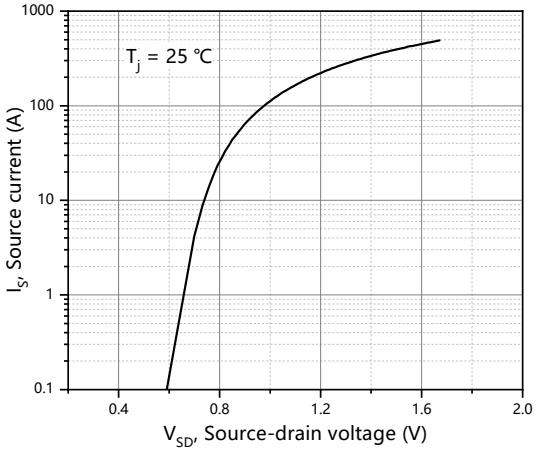


Figure 8. Forward characteristic of body diode

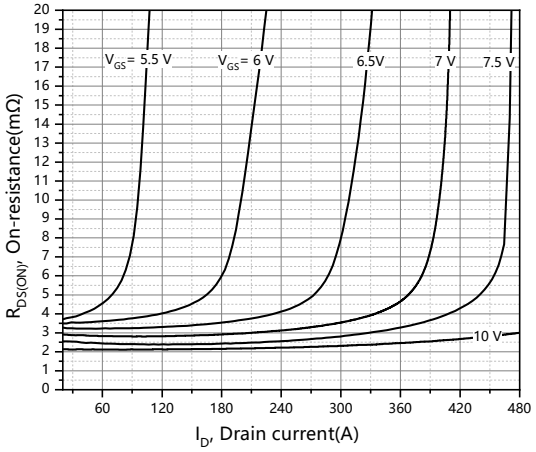


Figure 9. Drain-source on-state resistance

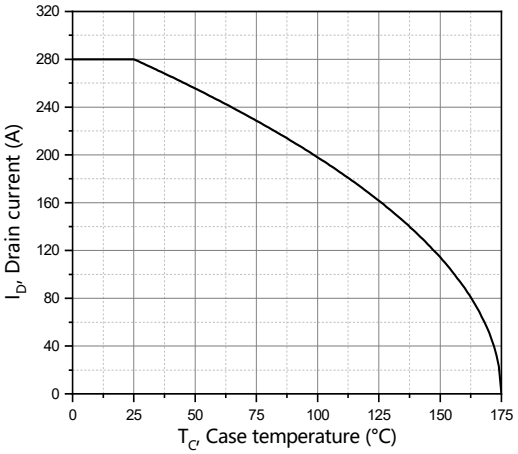


Figure 10. Drain current

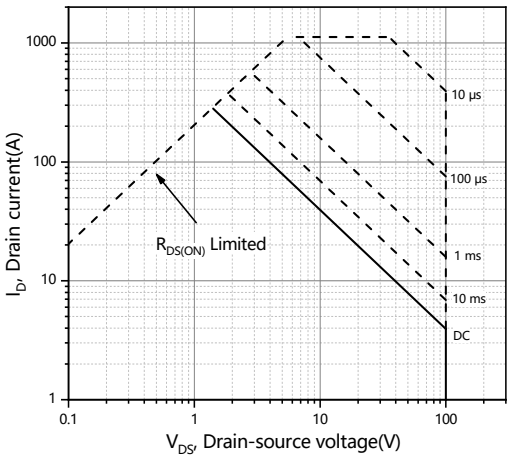


Figure 11. Safe operation area T_C=25℃

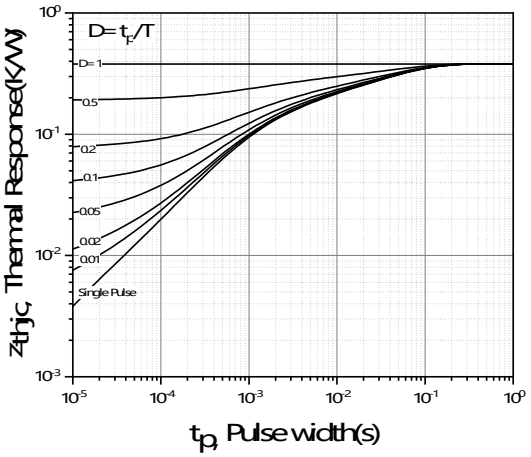


Figure 12. Max. transient thermal impedance

Test circuits and waveforms

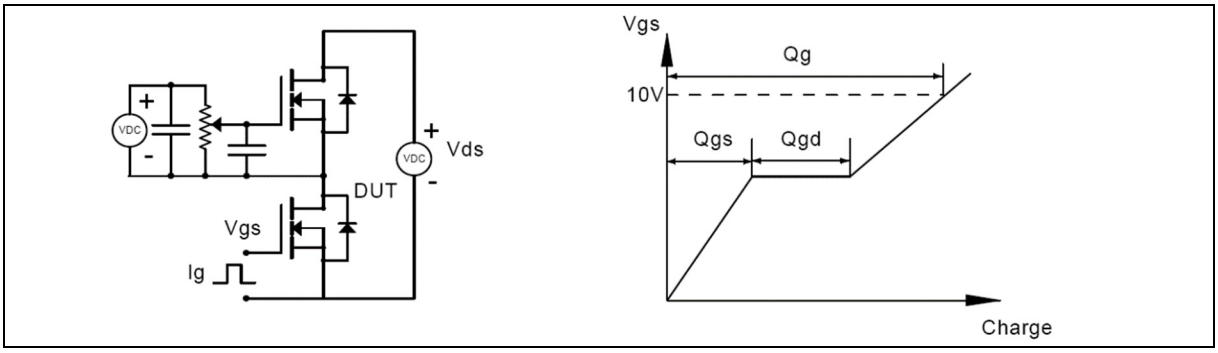


Figure 1. Gate charge test circuit & waveform

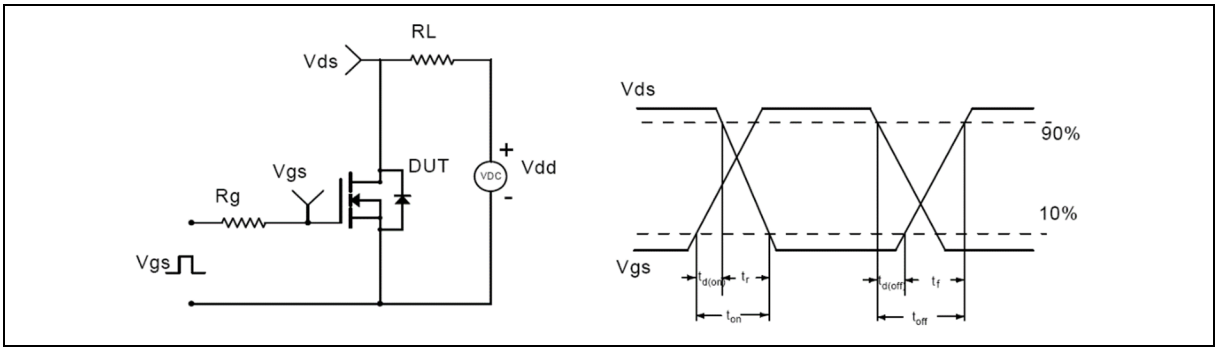


Figure 2. Switching time test circuit & waveforms

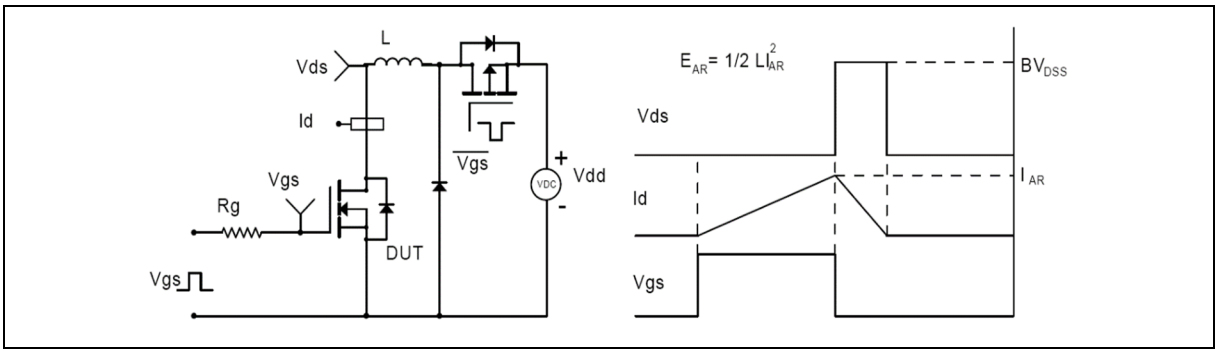


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

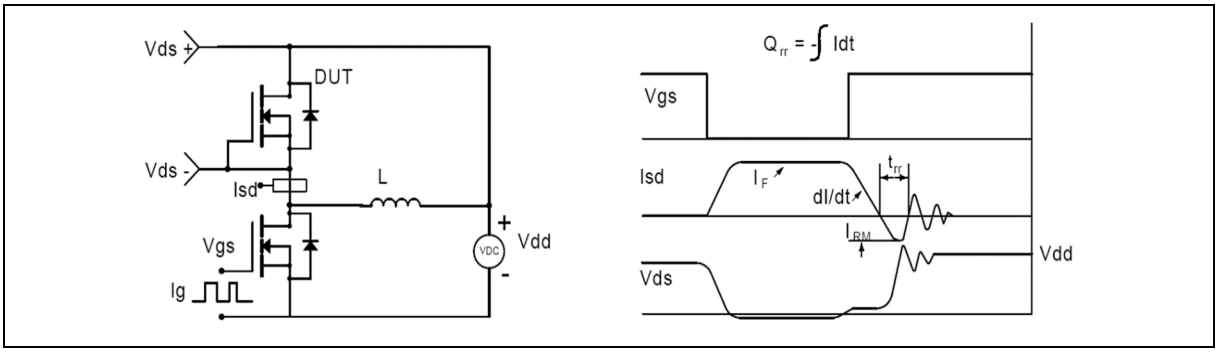
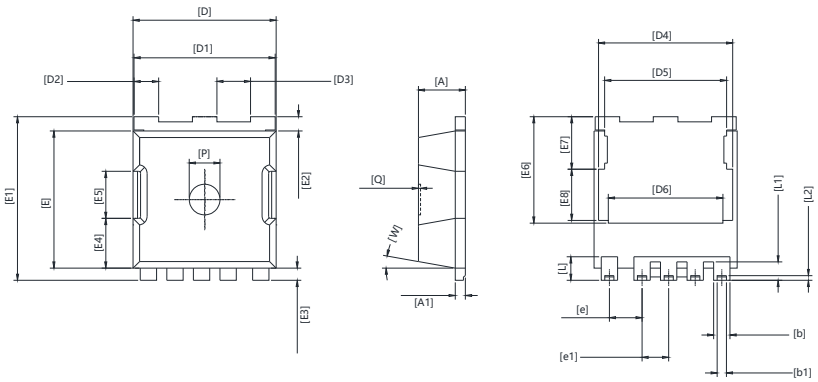


Figure 4. Diode reverse recovery test circuit & waveforms

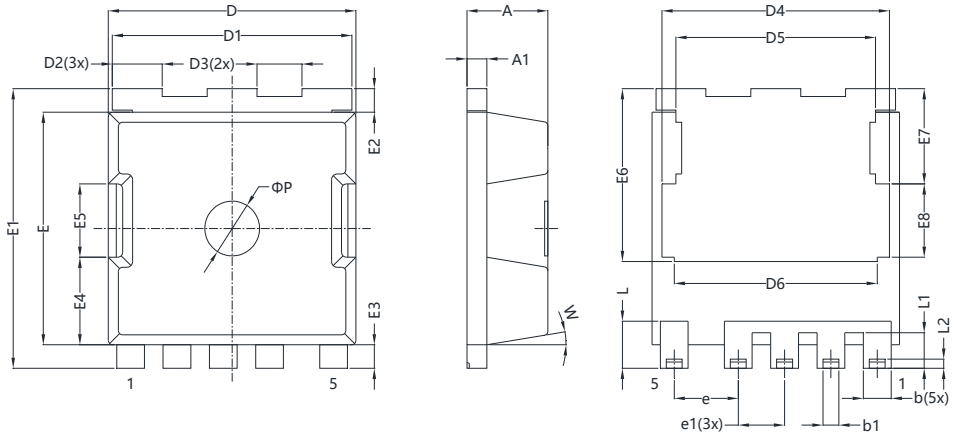
Package Information



Symbol	mm		
	Min	Nom	Max
A	2.25	2.30	2.45
A1	0.45	0.50	0.60
b	0.70	0.80	0.90
b1	0.42	0.45	0.50
D	6.80	7.00	7.20
D1	6.75	6.90	7.05
D2	1.05	1.20	1.35
D3	1.50	1.65	1.80
D4	6.56 BSC		
D5	5.96 BSC		
D6	5.6 BSC		
E	6.68	6.70	6.72
E1	7.80	8.00	8.20
E2	0.50	0.70	0.90
E3	0.48	0.60	0.72
E4	2.43 BSC		
E5	2.15	2.30	2.45
E6	5.2 BSC		
E7	2.57 BSC		
E8	2.5 BSC		
e	1.6 BSC		
e1	1.3 BSC		
L	0.95	1.15	1.35
L1	0.80	0.90	1.00
L2	0.13	0.24	0.33
ΦP	1.35	1.50	1.65
Q	—	—	0.10
W	9.9°	10°	10.1°

Version 1: sTOLL-J package outline dimension

Package Information



Symbol	mm		
	Min	Nom	Max
A	2.20	2.30	2.40
A1	0.40	0.50	0.60
b	0.70	0.80	0.90
b1	0.42	0.45	0.50
D	6.80	7.00	7.20
D1	6.80	6.90	7.00
D2	1.10	1.20	1.30
D3	1.55	1.65	1.75
D4	6.56 REF		
D5	5.96 REF		
D6	5.60 REF		
E	6.50	6.70	6.90
E1	7.80	8.00	8.20
E2	0.60	0.70	0.80
E3	0.50	0.60	0.70
E4	2.43 REF		
E5	2.30 REF		
E6	5.20 REF		
E7	2.57 REF		
E8	2.50 REF		
e	1.60 BSC		
e1	1.30 BSC		
L	1.05	1.15	1.25
L1	0.80	0.90	1.00
L2	0.13	0.235	0.33
P	1.40	1.50	1.60
W	8.50°	--	11.50°

Version 1: sTOLL-P package outline dimension

Ordering Information

Package Type	Units/ Reel	Reels / Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
sTOLL-J	2000	1	2000	10	20000
sTOLL-P	2000	2	4000	5	20000

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
SFS10R025UT1NF	sTOLL	yes	yes	yes

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